

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Kum Foo Leong et al.

Title: DIFFUSION BARRIER LAYER FOR LEAD FREE PACKAGE SUBSTRATE

Docket No.: 884.A68US1

Filed: September 29, 2003

Examiner: Nitin Parekh



Serial No.: 10/673,605

Due Date: July 30, 2004

Group Art Unit: 2811

Mail Stop Amendment

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

We are transmitting herewith the following attached items (as indicated with an "X"):

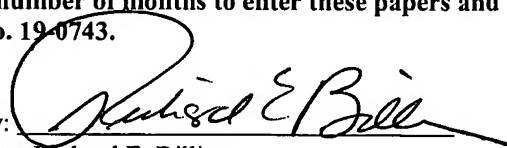
- ☒ A return postcard.
- ☒ Response to Restriction Requirement and Preliminary Amendment (6 Pages).
- ☒ Authorization to charge Deposit Account 19-0743 in the amount of \$18.00 to cover the fee for additional claims as calculated below.

If not provided for in a separate paper filed herewith, If an additional fee is required due to changes to the claims, the fee has been calculated as follows:

CLAIMS AS AMENDED						
	(1) Claims Remaining After Amendment		(2) Highest Number Previously Paid For	(3) Present Extra	Rate	Fee
TOTAL CLAIMS	31	-	30	1	x 18.00 =	\$18.00
INDEPENDENT CLAIMS	5	-	5	0	x 86.00 =	\$0.00
[]MULTIPLE DEPENDENT CLAIMS PRESENTED						\$0.00
TOTAL						\$18.00

Please consider this a PETITION FOR EXTENSION OF TIME for sufficient number of months to enter these papers and please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.
Customer Number 21186

By: 
Atty: Richard E. Billion
Reg. No. 32,836

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 30 day of July, 2004.

KACIA LEE
Name

Kacia Lee
Signature

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.
(GENERAL)

I.F.W

S/N 10/673,605

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Kum Foo Leong et al.

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Serial No.: 10/673,605

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Title: DIFFUSION BARRIER LAYER FOR LEAD FREE PACKAGE SUBSTRATE

Assignee: Intel Corporation

Customer No: 21186



RESPONSE TO RESTRICTION REQUIREMENT
AND PRELIMINARY AMENDMENT

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

In response to the Restriction Requirement mailed June 30, 2004, please amend the application as follows:

06/04/2004 SDIRETH1 00000084 130743 10673605

01 FC:1202 18.00 DA